

MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

TOUCH PANEL SPECIFICATION

Model: MI0430CCP-C

For Customer's Acceptance:

Customer		
Approved		
Comment		

Revision	1.2
Engineering	
Date	2013-05-09
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2012-05-15	Initial Release	
1.1	2012-09-14	Updating the viewing area size of cover lens.	
1.2	2013-05-09	Change operating temperature and storage temperature	

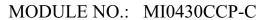




Table of Contents

1.	COVER & CONTENTS	1
2.	RECORD OF REVISION	2
3.	GENERAL SPECIFICATIONS······	3
4.	ELECTRICAL CHARACTERISTICS	3
5.	PIN CONNECTIONS ······	3
6.	TIMING CHARACTERISTICS	4
7.	INTERFACE AND DATA FORMAT······	5
8.	COMMAND	7
	COMMAND DESCRIPTION	
10.	BLOCK DIAGRAM·····	22
11.	QUALITY ASSURANCE	23
12.	APPEARANCE SPECIFICATION	24
13.	PRECAUTIONS IN USE CTP	27
14.	OUTLINE DRAWING	28



3. GENERAL SPECIFICATIONS

Item	Unit	
Туре	Transparent type projected capacitive touch panel	
Input mode	Human's finger	
Substrate Thickness	0.55	mm
Outline Dimension	115.1(W) x 73.9(H)*1.4(D)	mm
Transparency	≧85	%
Haze	≦1.0	%

4. ELECTRICAL CHARACTERISTICS

4.1 Absolute Maximum Ratings

Parameter	Symbol		Unit		
Faranietei	Syllibol	Min.	Тур.	Max.	
Supply voltage	VCC	-0.3	-	7	V
Switch control signals output current	Output current	-	50	-	mA
Enable control voltage range	Logic Input	-0.3	-	VCC+0.3	V
Output Control Driver	Output voltage	-0.3	-	VCC	V
Operating temperature	Temperature OP	-20		70	°C
Storage temperature	Temperature ST	-30		80	°C

4.2 DC characteristics

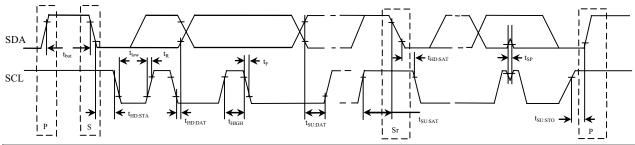
Parameter	Symbol		Unit			
Farameter	Symbol	Min.	Тур.	Max.	Unit	
Supply voltage	VCC	2.7	3.3	3.5		
Input high voltage	ViH	0.7 * VCC	-	VCC	V	
Input low voltage	VIL	0	-	0.3 *VCC	V	

5. PIN CONNECTIONS

No.	Name	I/O	Description			
1	GND	-	Ground			
2	GND	-	Ground			
3	XRES	I	NC pin; please keep floating			
4	XRES	I	NC pin; please keep floating			
5	INT	0	Interrupt, Active low			
6	INT	0	Interrupt, Active low			
7	SCL	I	Serial Clock access			
8	SCL	I	Serial Clock access			
9	SDA	I/O	Serial data access			
10	SDA	I/O	Serial data access			
11	VCC	-	Power; VCC=+3.3V			

Γ	12	VCC	-	Power; VCC=+3.3V
---	----	-----	---	------------------

6. TIMING CHARACTERISTICS



Parameter	Symbol		rd-Mode BUS	Fast-M I ² C-B	Unit	
		Min.	Max.	Min.	Max.	
SCL clock frequency	f_{SCL}	0	100	0	400	KHz
Bus free time between STOP and START condition	t _{BUF}	4.7	-	1.3	-	μs
Hold time (repeated) START condition. After this period, the first clock pulse is generated	t _{HD:STA}	4.0	-	0.6	-	μs
LOW period of the SCL clock	t_{LOW}	4.7	-	1.3	-	μs
HIGH period of the SCL clock	t _{HIGH}	4.0	-	0.6	-	μs
Set-up time for a repeated START condition	t _{SU:STA}	4.7	-	0.6	-	μs
Data hold time	$t_{HD:DAT}$	0	-	0	0.9	μs
Data set-up time	t _{SU:DAT}	250	-	100	-	μs
Rise time of both SDA and SCL signals	t_R	-	1000	20+0.1C _b	300	μs
Fall time of both SDA and SCL signals	t_{F}	1	300	20+0.1C _b	300	μs
Set-up time for STOP condition	$t_{SU:STO}$	4.0	-	0.6	-	μs
Capacitive load for each bus line.	C_b	-	400	-	400	pF

Note:

- (1) All values are referred to VIH (0.7xVCC) and VIL (0.3xVCC) level.
- (2) A device must internally provide a hold time of at least 300ns for the SDA signal (referred to the VIH of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.
- (3) The maximum $t_{HD:DAT}$ has only to be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal.
- (4) A fast-mode I²C-bus device can be used in a standard-mode I²C-bus system, but the requirement $t_{SU:DAT} \ge 250$ ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line $t_{R max}$ $t_{SU:DAT} = 1000+250=1250$ ns (according to the standard-mode I²C-bus specification) before the SCL line is released.
- (5) C_b = total capacitance of one bus line in pF.
- (6) If a spark or noise appear on SDA line and keep more than 25ns, Start or Stop condition will be identified if SCL

line keep high at this time.



7. Interface and Data Format

7.1 Transfer protocol (I²Cinterface)

MI0430CCP-C support I²C interface that need 2 hardware pin – serial data (SDA) and serial clock (SCL), carry information between the devices connected to the bus. The I²C bus supports serial, 8-bit oriented, bi-directional data transferred at a rate up to 100Kbit/s in the standard-mode, or up to 400Kbit/s in the fast-mode.

The data on the SDA line must be stable during the HIGH period of the clock. The HIGH or LOW state of the data line can only change when the clock signal on the SCL line is LOW.

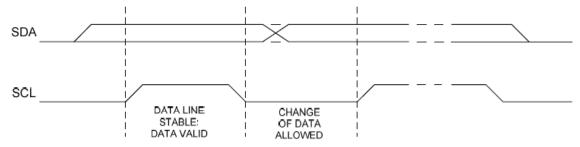


Figure 7.1: I²C Signal timing

Within the procedure of the I²C -bus, unique situations arise which are defined as START and STOP conditions. A HIGH to LOW transition on the SDA line while SCL is HIGH is one such unique case. This situation indicates a START condition. A LOW to HIGH transition on the SDA line while SCL is HIGH defines a STOP condition. START and STOP conditions are always generated by the master. The I²C bus is considered to be busy after the START condition. The I²C bus is considered to be free again a certain time after the STOP condition.

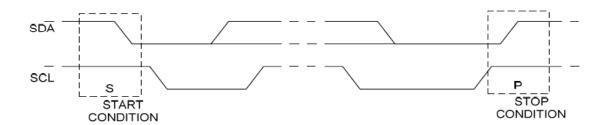


Figure 7.2: I²C Start/Stop

7.2 I²C data transfer

The CTP MI0430CCP-C I2C address is 0x90H

Each byte has to be followed by an acknowledge bit. Data is transferred with the most significant bit (MSB) first. Every byte put on the SDA line must be 8-bits long. The number of bytes that can be transmitted per transfer is unrestricted. If controller can't receive or transmit another complete byte of data until it has performed some other function, for example servicing an internal interrupt, it can hold the clock line SCL LOW to force the master into await state. Data transfer then continues when the controller is ready for another byte of data and releases clock line SCL.

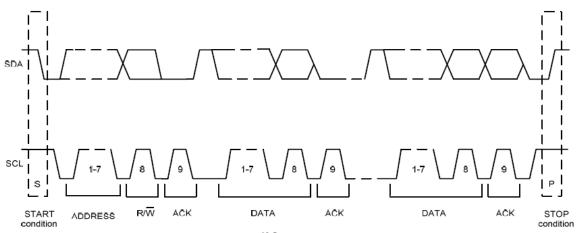
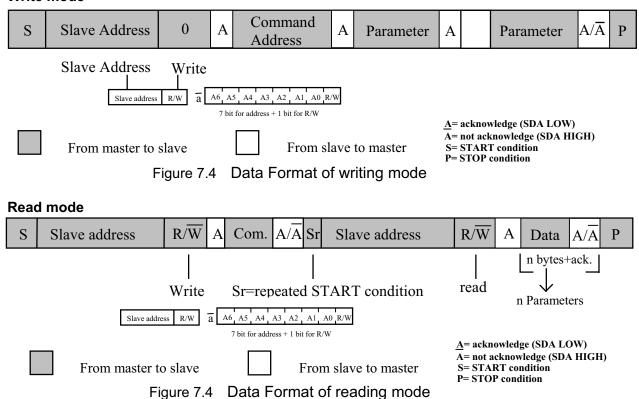


Figure 7.3: I²C data transfer

7.3 Format of data frame (I²C interface)

When master sends the command which be received by TP controller, the controller will responses the code and data. The format of communication is shown as Figure 7.4. The Command table that is written by master is defined on Command Table, Controller will response the response code first and data later.

Write mode





8. Command

8.1 Command list

Hex	Operation Code	D7	D6	D5	D4	D3	D2	D1	D0	Function
0	No operation	0	0	0	0	0	0	0	0	-
80	Sleep IN	1	0	0	0	0	0	0	0	-
81	Sleep Out	1	0	0	0	0	0	0	1	-
82	Sense Off	1	0	0	0	0	0	1	0	-
83	Sense On	1	0	0	0	0	0	1	1	-
	Read Event	1	0	0	0	0	1	0	1	-
	1st parameter	B31	B30	B29	B28	B27	B26	B25	B24	-
85	2nd parameter	B23	B22	B21	B20	B19	B18	B17	B16	-
	3rd parameter	B15	B14	B13	B12	B11	B10	В9	B8	-
	4th parameter	B7	B6	B5	B4	B3	B2	B1	B0	-
	Read All Events	1	0	0	0	0	1	1	0	-
	1st parameter	B31	B30	B29	B28	B27	B26	B25	B24	-
	2nd parameter	B23	B22	B21	B20	B19	B18	B17	B16	-
	3rd parameter	B15	B14	B13	B12	B11	B10	В9	B8	-
86	4th parameter	B7	B6	B5	B4	B3	B2	B1	B0	-
	5th parameter	E3	E2	E1	E0	FI	P2	P1	P0	-
	6th parameter	B23	B22	B21	B20	B19	B18	B17	B16	-
		:	:	:	:	:	:	:	:	-
	(n+1)th parameter	B7	B6	B5	B4	B3	B2	B1	B0	-
	Read Latest Event	1	0	0	0	0	1	1	1	-
	1st parameter	B31	B30	B29	B28	B27	B26	B25	B24	-
87	2nd parameter	B23	B22	B21	B20	B19	B18	B17	B16	-
	3rd parameter	B15	B14	B13	B12	B11	B10	B9	B8	-
	4th parameter	B7	B6	B5	B4	B3	B2	B1	B0	-
88	Clear Stack	1	0	0	0	1	0	0	0	-
9E	TS Software Reset	1	0	0	1	1	1	1	0	-

8.2 User define command list table

Hex	Operation Code	D7	D6	D5	D4	D3	D2	D1	D0	Function
	Device ID	0	0	1	1	0	0	0	1	Response Device ID Code
31h 1st parameter					8	35	-			
	2nd parameter		20							
	3nd parameter	00								-
32h	Version ID	0	0	1	1	0	0	0	1	Read Firmware version



9. Command description

9.1 NOP

00 H	NOP (N	o Opera	tion)							
	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX
Command	0	0	0	0	0	0	0	0	0	00
Parameter	No para	meter								
Description	This co		is an en	pty con	nmand a	nd it doe	s not ha	ve any e	ffect on	the
Restriction										
Da viata v			Status				A	vailability		
Register Availability		TS Sleep Out Yes								
		TS Sleep In Yes								
			Status				Def	fault Valu	е	
Default		Powe	r Up Sec	uence				N/A		
Belauk		TS S/W Reset N/A								
		I	H/W Res	et				N/A		
Flow Chart										



9.2 TS sleep in (80h)

80H	TSSLP	IN (Toucl	Screen	Sleep In)					
оип	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX
Command	0	1	0	0	0	0	0	0	0	80
parameter					No para	ameter				
Description		mmand c	auses th	e touch s	creen to	enter the	minimur	n power o	consump	tion
	mode.									
						and keep				
						h screen				node.
						S Sleep (ending ne				ow time
Restriction						stabilize		anu. mis	s is to air	JW IIIIE
						ding TS		t comma	nd (wher	n in TS
						nd can be			(
Register		,		•				بطناهاماني		
Availability			Status				A	vailability		
		TS	S Sleep (Out				Yes		
		7	S Sleep	In				Yes		
			Status				Det	ault Valu	е	
Default		Powe	r Up Sec	quence			TS SI	eep In M	ode	
		TS	S S/W Re	eset			TS SI	eep In M	ode	
		l	H/W Res	et			TS SI	eep In M	ode	
							Legend			
				rsslpin –		ĺ			1	
							Comma	and		
				Stop			Parame	eter /		
		<		DC/DC converter			/			
Flow Chart							Touc	ch een		
Flow Chart							A = 1 = -			
		<	/	Stop Internal Oscillator			Action			
				Jacillator			Mod	e		
				•						
		(TS	Sleep In Mo	de		Sequen transfer	tial		
		(



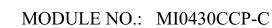
9.3 TS sleep out (81h)

9.3 TS sleep out	<u> </u>									
81H			ch Screer							
<u> </u>	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX
Command	0	1	0	0	0	0	0	0	1	81
parameter	No para		" TO	. Cla !						
Description			rns off TS			en is alrea	adv in TC	Sloop O:	ıt mada 3	T C
Restriction	Sleep O It will be the supp The touc during th function when the It will be	ut Mode of necessal oly voltage ch screen nis 5msect ality if fact touch so necessal	can only by try to wait es and clo loads all and ther tory defau creen is a ry to wait	be left by 5msec be ck circuit touch scree cannot ult and regarded TS 5msec af	the TS Slo efore send s to stabil reen supp be any ab gister valu S Sleep O ter sendir	eep In Co ding next o	mmand (8 command ory defaul ffect on th me when s. ep In com	30h). I. This is to It values to It e touch so It this load	o allow tir o the regi creen is done a	ne for sters
			Status				A	vailability		
Register Availability		T	S Sleep (Out				Yes		
•			ΓS Sleep	ln				Yes		
			Status				De	fault Valu	е	
Default		Powe	er Up Seq	uence			TS SI	leep In Mo	ode	
		TS	S S/W Re	set			TS SI	leep In Mo	ode	
			H/W Rese	et			TS SI	leep In Mo	ode	
Flow Chart	<		Start I DC/D conver	t al ttor				Command Parameter Touch Screen		
		TS	▼ Sleep 0	Out Mode				Mode Sequential ransfer		



9.4 TS sense off (82h)

9.4 TS sense o		= /Touch	Screen S	ongo Off)						
82H	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX
Command	0	1	0	0	0	0	0	1	0	82
parameter	No para	meter								02
Description	The tou	ch screer	n is not se	ensing to	uches (=	No new e	events), b	ut the tou	ich scree	n is still
Restriction	scanning	g								
Register			Status	2			Α	vailability		
Availability			S Sleep (TS Sleep					Yes Yes		
			Status				De	fault Valu		
D ()		Powe	er Up Seq	uence				Sense O		
Default			S S/W Re					Sense O		
			H/W Rese	et			TS	Sense O	ff	
Flow Chart			TSSOF				Z F	Command Parameter Touch Screen Action Mode		





9.5 TS sense on (83h)

83H	on (83h) TSSON	(Touch S	creen Sei	nse On)						
83H	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX
Command	0	1	0	0	0	0	0	1	1	83
parameter	No para									
Description	The tou	ch screen	is sensin	g touches	s (= No ne	ew events).			
Restriction										
Register			Status				A	vailability		
Availability		T	S Sleep (Out				Yes		
			ΓS Sleep	ln				Yes		
			Status				De	fault Valu	е	
Default		Powe	er Up Seq	uence			TS	Sense O	ff	
		TS	S S/W Re	set			TS	Sense O	ff	
			H/W Rese	et			TS	Sense O	ff	
Flow Chart			TSSON TSSON				Z F	Touch Screen Action Mode		



9.6 Read One Event (85h)

85H	ROE (F	Read One	Event)							
оэп	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX
Command	0	1	0	0	0	0	1	0	1	85
1 parameter	-	B31	B30	B29	B28	B27	B26	B25	B24	XX
2 parameter	-	B23	B22	B21	B20	B19	B18	B17	B16	XX
3 parameter	-	B15	B14	B13	B12	B11	B10	В9	B8	XX
4 parameter	-	B7	B6	B5	B4	B3	B2	B1	B0	XX

Description

This command returns one touch event what is the oldest co-ordinates or raw counter (dc) values information has been stored on the stock. The event stack is empty after this command.

A returning value can be "No Event" if the stock is empty.

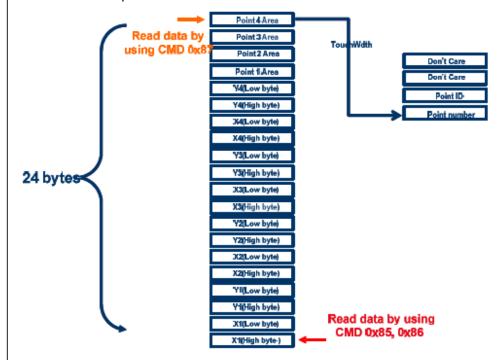
co-ordinates and related touch information:

Touch Width: Report the touched block. For example: if RX=15, TX=10, the total

Block is 150 (96h). If it has three touched block, the report value is 03h.

Point ID: Report the ID of touched points.

Points number: Report the touch number.



When one or more points (but not all) have been touched, other points without touched will be fill invalid data 0xFFFF to let baseband distinguish which point has been touched or not.



Register	Status	Availability
Availability	TS Sleep Out	Yes
	TS Sleep In	Yes
	Status	Default Value
Default	Power Up Sequence	0000 0000h
Default	TS S/W Reset	0000 0000h
	H/W Reset	0000 0000h
Flow Chart	Send 1 st parameter Send 2 nd parameter Send 3 rd parameter Send 4 th parameter	Command Parameter Touch Screen Action Mode Sequential transfer



9.7 Read All Event (86h)

Command 1 parameter 2 parameter 3 parameter 4 parameter 5 parameter 6 parameter : (n+1) Parameter Th cool be co- To Blo Po Po	RAE (Read All DNC D7 0 1 - B31 - B23 - B15 - B7 - E3 - B23 - : B7 This command counter (dc) value "No Event" is co-ordinates ar Touch Width: Fellock is 150 (9) Point ID: Report
Command 1 parameter 2 parameter 3 parameter 4 parameter 5 parameter 6 parameter : (n+1) Parameter Th cor be co- To Blo Po Po	0 1 B31 B23 B15 B7 B7 B23 B23 B23 B7 This command counter (dc) vace "No Event" ico-ordinates ar Touch Width: Fellock is 150 (9)
1 parameter 2 parameter 3 parameter 4 parameter 5 parameter 6 parameter : (n+1) Parameter The column be co- To Blo	B31 B23 B15 B7 B7 B23 B23 B23 B23 B7 This command counter (dc) vacue "No Event" ico-ordinates ar Touch Width: Fellock is 150 (9) Point ID: Report
2 parameter 3 parameter 4 parameter 5 parameter 6 parameter : (n+1) Parameter Th cor be co- To Blo Po Po	B23 B15 B7 B3 B23 B23 B23 B23 B23 B23 B7 This command counter (dc) value "No Event" ico-ordinates ar Touch Width: Fellock is 150 (9) Point ID: Report
3 parameter 4 parameter 5 parameter 6 parameter : (n+1) Parameter Th coube co- To Blo	B15 B7 B3 B23 B23 B7 B7 B7 This command counter (dc) vace "No Event" ico-ordinates ar Touch Width: FBlock is 150 (9)
4 parameter 5 parameter 6 parameter : (n+1) Parameter Th columber co- To Blo	B7 B23 B23 B7 B7 B7 B7 This command counter (dc) vace "No Event" ico-ordinates ar Touch Width: FBlock is 150 (9)
5 parameter 6 parameter : (n+1) Parameter Th coulobe co- To Blo Po Po	E3 B23 B7 This command counter (dc) vace "No Event" ico-ordinates ar Touch Width: FBlock is 150 (9)
6 parameter : (n+1) Parameter Th core be co- To Blo	B23 B7 This command counter (dc) value "No Event" ico-ordinates ar Touch Width: FBlock is 150 (9) Point ID: Report
: (n+1) Parameter Th cor be co- To Blo Po Po	- : B7 This command counter (dc) value "No Event" ico-ordinates ar Touch Width: FBlock is 150 (9) Point ID: Report
(n+1) Parameter Th col be co- To Blo Po Po	B7 This command counter (dc) value "No Event" ico-ordinates ar Touch Width: FBlock is 150 (9) Point ID: Report
The corresponding to the corre	This command counter (dc) vance "No Event" ico-ordinates ar Touch Width: Felock is 150 (9) Point ID: Report
be co- To Blo Po Po Description	counter (dc) va be "No Event" i co-ordinates ar Touch Width: F Block is 150 (9 Point ID: Repo
What tou be Register	Points number:



	TS Sleep Out	Yes
	TS Sleep In	Yes
	Status	Default Value
Default	Power Up Sequence	All Values 0000 0000h
	TS S/W Reset	All Values 0000 0000h
Flow Chart	I ² C Mode Read RAE Host Touch Screen	Command Parameter Touch Screen Action Mode Sequential transfer



9.8 Read Latest Event (87h)

87H	R	LE (R	ead Late	st Event	:)						
0/11	D	NC	D7	D6	D5	D4	D3	D2	D1	D0	HEX
Command		0	1	0	0	0	0	1	1	1	87
1 parameter		-	B31	B30	B29	B28	B27	B26	B25	B24	XX
2 parameter		-	B23	B22	B21	B20	B19	B18	B17	B16	XX
3 parameter		-	B15	B14	B13	B12	B11	B10	B9	B8	XX
4 parameter		-	B7	B6	B5	B4	B3	B2	B1	В0	XX

Description

This command returns one touch event what is the oldest co-ordinates or raw counter (dc) values information has been stored on the stock. The event stack is empty after this command.

A returning value can be "No Event" if the stock is empty.

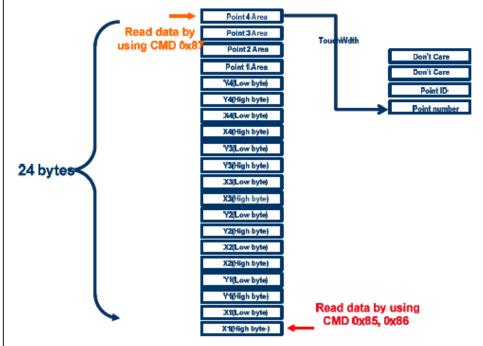
co-ordinates and related touch information:

Touch Width: Report the touched block. For example: if RX=15, TX=10, the total

Block is 150 (96h). If it has three touched block, the report value is 03h.

Point ID: Report the ID of touched points.

Points number: Report the touch number.



When one or more points (but not all) have been touched, other points without touched will be fill invalid data 0xFFFF to let baseband distinguish which point has been touched or not.



Register Availability	Status TS Sleep Out	Availability Yes
, wanaziniy	TS Sleep In	Yes
Flow Chart	Send 1st parameter Send 2nd parameter Send 3rd parameter Send 4th parameter	Command Parameter Touch Screen Action Mode Sequential transfer





9.9 Clear Event Stack (88h)

9.9 Clear Ever		<u> </u>								
88H		(Clear E			D.4	D.C.	D0	D.4	D 0	LUEY
Command	DNC 0	D7 1	D6 0	D5 0	D4 0	D3	D2 0	D1 0	D0 0	HEX 88
parameter	No para	1	U		0	l I	0	0	U	00
Description			lears eve	ent stack	when the	only retu	ırn event	can be "	No Even	t".
Restriction										
Register			Status				A	vailability		
Availability			S Sleep (Yes		
		٦	S Sleep	In				Yes		
			Status				Def	fault Valu	е	
Default		Powe	r Up Sec	luence			En	npty Stacl	<	
			S S/W Re					npty Stacl		
			H/W Res	et			En	npty Stacl	Κ	
Flow Chart		Cle	CLRE				Pa See	ommand arameter Touch Screen Action Mode		



9.10 TS Software Reset (9Eh)

		9.10 TS Software Reset (9Eh) TSSWRESET (Touch Screen Software Reset)									
9E H	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX	
Command	0	1	0	0	1	1	1	1	0	9E	
parameter	No para	ı <u> </u>									
Description	When the Touch Screen Software Reset command is written, it causes a software reset. It resets the commands and parameters to their TS S/W Reset default values. (See default tables in each command description.) Note: The Memory contents are unaffected by this command										
Restriction	It will be necessary to wait 5msec before sending new command following software reset. The touch screen loads all touch screen supplier's factory default values to the registers during this 5msec. If Software Reset is applied during TS Sleep Out mode, it will be necessary to wait 5msec before sending TS Sleep Out command. Touch Screen Software Reset Command cannot be sent during TS Sleep Out sequence.									e wait	
Register			Status			A	vailability				
Availability			S Sleep				Yes				
		٦	S Sleep	In			Yes				
			Status		Default Value						
Default			r Up Sed		N/A						
			S S/W Re		N/A						
			H/W Res	et	N/A						
Flow Chart		Set of to De	SWRES	nds / ue	>			Comman Paramete Touch Screen Action Mode			



9.11 Device ID Command (31h)

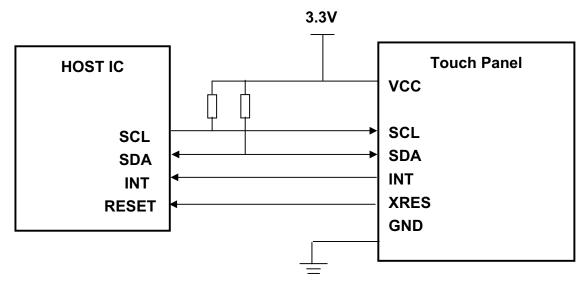
31 H	Device ID											
31 11	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX		
Command	0	0	0	1	1	0	0	0	1	31		
1 parameter	1 85							00F				
2 parameter	1 26						00FF					
3 parameter	1	1 00 00F						00FF				
Description When the Device ID command is written, IC will echo the device ID to index of Device ID command is 31h						to maste	er. The					
Register	Status						Availability					
Availability	TS Sleep Out						Yes					
	TS Sleep In						Yes					
	Status						Default Value					
Default	Power Up Sequence						N/A					
Delault	TS S/W Reset						N/A					
	H/W Reset						N/A					
Flow Chart												

9.12 Version ID Command (32h)

3.12 Version is Communa (CEN)												
32 H	Device ID											
32 11	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX		
Command	0	0	0	1	1	0	0	1	0	31		
1 parameter	1		SF_Ver	sion[3:0]		F_Version[3:0] 00FF						
Description	This command will report the ID code of firmware Version. F_Version [3:0]: The firmware version of flash code. SF Version [3:0]: The firmware version of self test code.											
Register Availability					Availa Yes Yes							
	Status						Default Value					
Default	Power			N/A								
	TS S/W Reset						N/A					
	H/W Reset					N/A						
Flow Chart												



10. BLOCK DIAGRAM



Note: 1. USE APPROPRIATE RESISTOR VALUE DURING HIGH SPEED SCL CLOCK.

SUGGESTION: RESISTOR RECOMMENDATION: 1K ohm.

2. To reduce the noise from the power, we suggest you use the independent power for the touch panel (VCC)



11. QUALITY ASSURANCE

11.1 Test Condition

11.1.1 Temperature and Humidity (Ambient Temperature)

Temperature: $25 \pm 5^{\circ}$ C Humidity: $65 \pm 5\%$

11.1.2 Operation

Unless specified otherwise, test will be conducted under function state.

11.1.3 Container

Unless specified otherwise, vibration test will be conducted to the product itself without putting it in a container.

11.1.4 Test Frequency

In case of related to deterioration such as shock test. It will be conducted only once.

11.1.5 Test Method

	Reliability Test Item & Level	Test Level					
No.	Test Item						
1.	High Temperature Storage Test	T= 80,°C 120hrs after 1 hrs at room temperature and test.					
2.	Low Temperature Storage Test	T= -30 $^{\circ}$ C, 120hrs after 1 hrs at room temperature and test.					
3.	High Temperature Operation Test	T= 70° C 120hrs after 1 hrs at room temperature and test.					
4.	Low Temperature Operation Test	T= -20 $^{\circ}$ C, 120hrs after 1 hrs at room temperature and test.					
3.	High Temperature and High Humidity Storage Test	T= 40°C, 90%RH,120hrs after 24 hrs at room temperature and test.					
4.	Thermal Cycling Test (No operation)	-30 $^{\circ}$ C 30min ~ 80 $^{\circ}$ C 30 min , 100 Cycles after 24 hrs at room temperature and test.					
5.	Vibration Test (No operation)	Frequency :10 ~ 55 HZ Amplitude :1.5 mm Sweep time : 11 mins Test Period: 6 Cycles for each direction of X, Y, Z					
6.	ESD TEST	Air Discharge : ±8KV Indirect Contact Discharge : ±4KV					





12. APPEARANCE SPECIFICATION

12.1Inspection and Environment conditions

12.1.1 Temperature: 25± 5°C 12.1.2 Humidity: 55 ± 10% RH

12.1.3 Light source: Fluorescent Light

12.1.4 Inspection: Viewing distance: 35±5cm

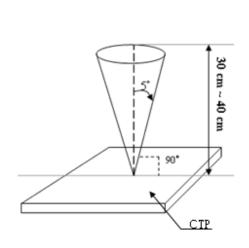
12.1.5 Ambient Illumination:

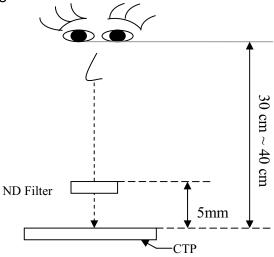
(1) Cosmetic Inspection: 500 ~ 800 lux(2) Functional Inspection: 400 ~ 600 lux

12.1.6 Inspection View angle:

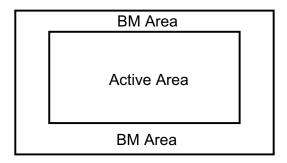
(1) Inspection under operating condition: ±5°

(2) Inspection under non-operating condition: ± 45°





12.2 Definition of applicable Zones



12.3 Judgment standard

The Judgment of the above test should be made after exposure in room temperature for two hours as follow:

Pass: Normal display image with no obvious non-uniformity and no line defect.

Partial transformation of the module parts should be ignored.

Fail: No display image, obvious non-uniformity, or line defect.



12.4 Cosmetic Specification and Inspection Items									
Inspection Item	Inspection	on Criteri	Illustration						
Foreign material (Black or White spots shape)	Zone Dimension D> 0.5 mm 0.3 mm $\leq D \leq 0.5$ mm D< 0.3 mm	number Defects 5 mm 0 D≤0.5mm 5 Minor		D= (L + W) / 2					
Foreign Material (Line shape)	Zone Dimension W> 0.1mm or L>10mm 0.05 mm≦W≤0.1 mn ≤10mm W< 0.05mm		L : Long W : Width						
Dimension	Outline		(Major)						
Scratch on the Touch panel	$\begin{tabular}{ c c c c c }\hline Zone \\\hline Dimension \\\hline W> 0.1mm \ or \ L \\\hline >10mm \\\hline W\le 0.1 \ mm \ L\le \\\hline 10mm \\\hline \end{tabular}$	Acceptable number 0	Class of Defects Minor	L2					
Dent on the Touch panel	Zone Dimension $D > 0.5 \text{ mm}$ $0.3 \text{mm} \leq D \leq 0.5 \text{ mn}$	Acceptable number 0	L D= (L + W) / 2						
Corner Chipping	X<3 mm, Y<3 thic	3 mm, Z< G kness	x y z						
Edge Chipping	X<3 mm, Y<3 thic	3 mm, Z< G kness	T						
Crack	re	eject	4						



13. PRECAUTIONS IN USE CTP

1. ASSEMBLY PRECAUTIONS

- (1) Since Touch Panel is consist of glass, please be careful your hands to be injured during handing. You must wear gloves during handing.
- (2) Do not touch, push or rub the exposed touch panel, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment.
- (3) Do not stack the touch panels together. Do not put heavy objects on touch panel.
- (4) Please do not take a CTP to pieces and reconstruct it. Resolving and reconstructing modules may cause them not to work well.
- (5) Please excessive force or strain to the panel or tail is prohibited, Do not lift touch panel by cable(FPC).
- (6) Use clean sacks or glove to prevent fingerprints and/or stains left on the panel. Extra attention and carefulness should be taken while handling the glass edge.
- (7) Please pay attention for the matters stated below at mounting design of touch panel enclosure.

 Enclosure support to fix touch panel must be out of active area.(do not design enclosure presses the active area to protect from miss put)

2. OPERATING PRECAUTIONS

- Please be sure to turn off the power supply before connecting and disconnecting signal input cable.
- (2) Please do not change variable resistance settings in CTP. They are adjusted to the most suitable value. If they are changed, it might happen CTP does not satisfy the characteristics specification
- (3) Be careful for condensation at sudden temperature change. Condensation makes damage to sensor or electrical contacted parts.
- (4) CTP has high frequency circuits. Sufficient suppression to the electromagnetic interference 7. shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- (5) Touch the panel with your finger or stylus only to assure normal operation. Any sharp edged or hard objects are prohibited.
- (6) Operate the panel in a steady environment. Abrupt variation on temperature and humidity may cause malfunction of the panel.

3. ELECTROSTATIC DISCHARGE CONTROL

(1) The operator should be grounded whenever he/she comes into contact with the CTP. Never touch any of the conductive parts such the copper leads on the FPC and the interface terminals with any parts of the human body.

- (2) The CTP should be kept in antistatic bags or other containers resistant to static for storage.
- Only properly grounded soldering irons should be used.
- (4) If an electric screwdriver is used, it should be well grounded and shielded from commentator sparks.
- (5) The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended
- (6) Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

5. STORAGE PRECAUTIONS

- (1) When you store touch panel for a long time, it is recommended to keep the temperature between $0^{\circ}\text{C}\text{-}40^{\circ}\text{C}$ without the exposure of sunlight and to keep the humidity less than 90%RH.
- (2) Please do not leave touch panel in the environment of high humidity and high temperature such as 60°C 90%RH
- (3) Please do not leave touch panel in the environment of low temperature; below -20°C.

6. OTHERS

For the packaging box, please pay attention to the followings:

- a. Please do not pile them up more than 5 boxes.
 (They are not designed so.) And please do not turn over
- b. Please handle packaging box with care not to give them sudden shock and vibrations. And also please do not throw them up.
- Packing box and inner case for CTP are made of cardboard. So please pay attention not to get them wet. (Such like keeping them in high humidity or wet place can occur getting them wet.)

7. LIMITED WARRANTY

Unless otherwise agreed between MULTI-INNO and customer, MULTI-INNO will replace or repair any of its CTP which is found to be defective electrically and visually when inspected in accordance with MULTI-INNO acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of MULTI-INNO is limited to repair and/or replacement on the terms set forth above. MULTI-INNO will not responsible for any subsequent or consequential events.



14. OUTLINE DRAWING

